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FAST CMOS OCTAL D REGISTER (3-STATE)

IDT74FCT2374AT/CT

FEATURES:

- A and C grades
- Low input and output leakage ≤1µA (max.)
- CMOS power levels
- True TTL input and output compatibility:
 - VOH = 3.3V (typ.)
 - -VOL = 0.3V (typ.)
- Meets or exceeds JEDEC standard 18 specifications
- Resistor outputs -15mA IOH, 12mA IOL
- · Reduced system switching noise
- Available in QSOP package

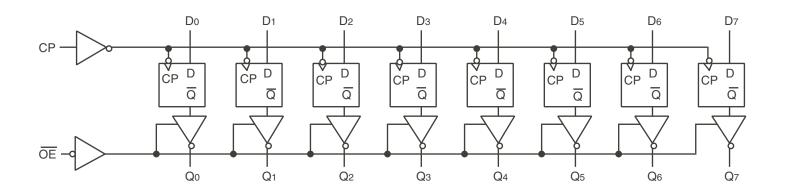
DESCRIPTION:

The FCT2374T is an 8-bit register built using an advanced dual metal CMOS technology. These registers consist of eight D-type flip-flops with a buffered common clock and buffered 3-state output control. When the output enable (\overline{OE}) input is low, the eight outputs are enabled. When the \overline{OE} input is high, the outputs are in the high-impedance state.

Input data meeting the set-up and hold time requirements of the D inputs is transferred to the Q outputs on the low-to-high transition of the clock input.

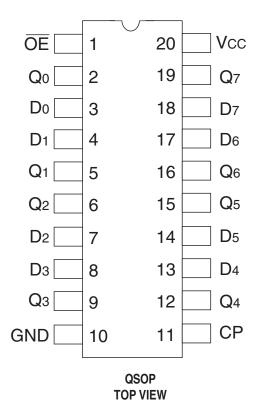
The FCT2374T has balanced output drive with current limiting resistors. This offers low ground bounce, minimal undershoot and controlled output fall times-reducing the need for external series terminating resistors. FCT2374T parts are plug-in replacements for FCT374T parts.

FUNCTIONAL BLOCK DIAGRAM



The IDT logo is a registered trademark of Integrated Device Technology, Inc.

PIN CONFIGURATION



ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +7	٧
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
Tstg	Storage Temperature	-65 to +150	°C
lout	DC Output Current	-60 to +120	mA

NOTES:

- 1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability. No terminal voltage may exceed Vcc by +0.5V unless otherwise noted.
- 2. Inputs and Vcc terminals only.
- 3. Output and I/O terminals only.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

	Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
	CIN	Input Capacitance	VIN = 0V	6	10	рF
ſ	Соит	Output Capacitance	Vout = 0V	8	12	pF

NOTE:

1. This parameter is measured at characterization but not tested.

PIN DESCRIPTION

Pin Names	Description
Dx	D flipflop data inputs
СР	Clock Pulse for the register. Enters data on LOW-to-HIGH transition
Qx	3-State Outputs (TRUE)
Qx	3-State Outputs (INVERTED)
ŌĒ	3-State Output Enable Input (Active LOW)

FUNCTION TABLE(1)

	Inputs			Outputs	Internal
Function	ŌĒ	СР	Dx	Qx	Qx
High-Z	Н	L	Х	Z	NC
	Н	Н	Χ	Z	NC
Load	L	1	L	L	Н
Register	L	↑	Н	Н	L
	Н	1	L	Z	Н
	Н	↑	Н	Z	L

NOTE:

- 1. H = HIGH Voltage Level
 - X = Don't Care
 - L = LOW Voltage Level
 - Z = High Impedance
 - NC = No Change
- ↑ = LOW-to-HIGH transition

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Industrial: TA = -40°C to +85°C, VCC = $5.0V \pm 5\%$

Symbol	Parameter	Test Con	ditions ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Unit
VIH	Input HIGH Level	Guaranteed Logic HIGH Level		2	_	_	V
VIL	Input LOW Level	Guaranteed Logic LOW Level		_	_	0.8	V
lih	Input HIGH Current ⁽⁴⁾	Vcc = Max.	VI = 2.7V	_	_	±1	μA
lıL	Input LOW Current ⁽⁴⁾	Vcc = Max.	VI = 0.5V	_	_	±1	μA
lozh	High Impedance Output Current	Vcc = Max.	VI = 2.7V	_	_	±1	μA
lozL	(3-State Output Pins)(4)		VI = 0.5V	–	–	±1	
lı	Input HIGH Current ⁽⁴⁾	Vcc = Max., Vi = Vcc (Max.)		_	_	±1	μA
Vik	Clamp Diode Voltage	Vcc = Min., IIN = -18mA	Vcc = Min., IIN = -18mA		-0.7	-1.2	V
VH	Input Hysteresis	_		_	200	_	mV
Icc	Quiescent Power Supply Current	Vcc = Max. Vin = GND or Vcc			0.01	1	mA

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
IODL	Output LOW Current	$VCC = 5V$, $VIN = VIH or VIL$, $VOUT = 1.5V^{(3)}$		16	48		mA
lodh	Output HIGH Current	$VCC = 5V$, $VIN = VIH or VIL$, $VOUT = 1.5V^{(3)}$		-16	-48	_	mA
Voн	Output HIGH Voltage	Vcc = Min	IOH = -15mA	2.4	3.3	_	V
		VIN = VIH or VIL					
Vol	Output LOW Voltage	Vcc = Min	IoL = 12mA	_	0.3	0.5	V
		VIN = VIH or VIL					

NOTES:

- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Not more than one output should be tested at one time. Duration of the test should not exceed one second.
- 4. The test limit for this parameter is $\pm 5 \mu A$ at TA = -55°C.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions(1)		Min.	Typ.(2)	Max.	Unit
Δlcc	Quiescent Power Supply Current TTL Inputs HIGH	Vcc = Max. $Vin = 3.4V^{(3)}$		_	0.5	2	mA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = Max. Outputs Open OE = GND One Input Toggling	VIN = VCC VIN = GND	_	0.06	0.12	mA/ MHz
		50% Duty Cycle					
Ic	Total Power Supply Current ⁽⁶⁾	Vcc = Max. Outputs Open fcP = 10MHz	VIN = VCC VIN = GND	_	0.6	2.2	mA
		50% Duty Cycle					
		OE = GND fi = 5MHz 50% Duty Cycle	VIN = 3.4V VIN = GND	_	1.1	4.2	
		One BitToggling					
		Vcc = Max. Outputs Open fcp = 10MHz	VIN = VCC VIN = GND	_	1.5	4(5)	
		50% Duty Cycle OE = GND Eight Bits Toggling fi = 2.5MHz	VIN = 3.4V VIN = GND	_	3.8	13 ⁽⁵⁾	
		50% Duty Cycle					

NOTES:

- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Per TTL driven input; (VIN = 3.4V). All other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of Δ Icc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC
 - $Ic = Icc + \Delta Icc DhNT + IccD (fcp/2+ fiNi)$
 - Icc = Quiescent Current
 - ΔIcc = Power Supply Current for a TTL High Input (VIN = 3.4V)
 - DH = Duty Cycle for TTL Inputs High
 - NT = Number of TTL Inputs at DH
 - ICCD = Dynamic Current caused by an Input Transition Pair (HLH or LHL)
 - fcP = Clock Frequency for Register Devices (Zero for Non-Register Devices)
 - fi = Output Frequency
 - Ni = Number of Outputs at fi
- All currents are in milliamps and all frequencies are in megahertz.

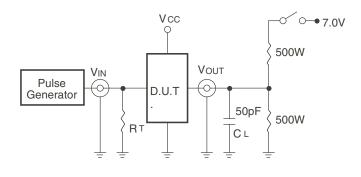
SWITCHING CHARACTERISTICS OVER OPERATING RANGE(1)

			74FCT2374AT		74FCT2	2374CT	
Symbol	Parameter	Condition ⁽¹⁾	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Unit
tPLH	Propagation Delay	CL = 50 pF	2	6.5	2	5.2	ns
tPHL	CP to Qx	$RL = 500\Omega$					
tpzh	Output Enable Time		1.5	6.5	1.5	5.5	ns
tPZL							
tphz	Output Disable Time		1.5	5.5	1.5	5	ns
tPLZ							
tsu	Set-up Time HIGH or LOW, Dx to CP		2	_	2	_	ns
tH	Hold Time HIGH or LOW, Dx to CP		1.5	_	1.5	_	ns
tw	CP Pulse Width HIGH or LOW ⁽³⁾		5	_	5	_	ns

NOTES:

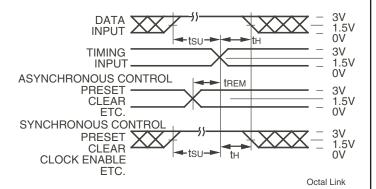
- 1. See test circuit and waveforms.
- 2. Minimum limits are guaranteed but not tested on Propagation Delays.
- 3. This parameter is guaranteed but not tested.

TEST CIRCUITS AND WAVEFORMS

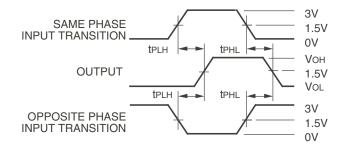


Test Circuits for All Outputs

Octal Link



Set-Up, Hold, and Release Times



Propagation Delay

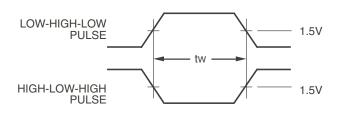
SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

DEFINITIONS:

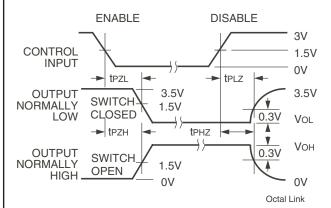
CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZouT of the Pulse Generator.



Pulse Width

Octal Link



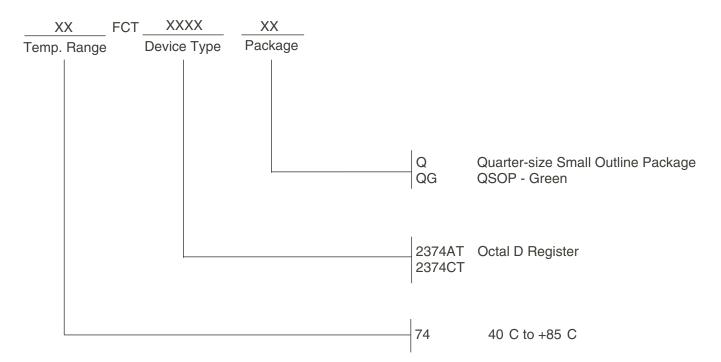
Enable and Disable Times

NOTES:

Octal Link

- 1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns.

ORDERING INFORMATION



Datasheet Document History

09/29/09 Pg. 7 Updated the ordering information by removing the "IDT" notation and non RoHS part.



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